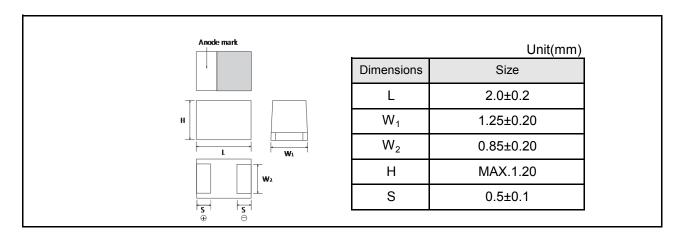
Chip tantalum capacitors (New bottom surface electrode type : Extra large capacitance) **TCS series P case**

Datasheet

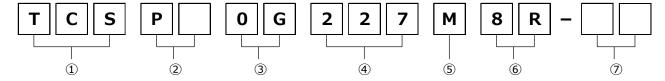
Features

- 1) New bottom electrode configuration results in greater compactness, low profile, and higher capacitance.
- 2) Compact, low profile, ultra-high capacitance contribute to smaller, thinner sets with greater functionality.
- 3) Ideal for noise removal on power supply lines with limited space.
- 4) Eco-friendly halogen-free products.

Dimensions



Part No. Explanation



- ① Series name TCS
- ② Case code P: 2012-12(0805)size
- 3 Rated voltage

rated reliage	
Code	Rated voltage(V)
0E	2.5
0G	4
0J	6.3
1A	10
1B	13
1C	16
1D	20
1E	25
1V	35

- 4 Nominal capacitance
 - Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.
- ⑤ Capacitance tolerance

M: ±20%

6 Taping

8: Real width: 8mm

R: Positive electrode on the side opposite to sprocket hole

⑦ Discrimination code

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Rated table

Capacitance	Rated voltage(V.DC)						
(µF)	4	6.3	10	16	20	25	35
1.0 (105)							
2.2 (225)							
3.3 (335)							
4.7 (475)							
10 (106)					Р		
15 (156)							
22 (226)							
33 (336)							
47 (476)			Р				
100 (107)		Р					
150 (157)		Р					
220 (227)	Р						

Remark) Case size codes (P) in the above show products line-up.

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity : The polarity should be shown by \square bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

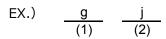
Voltage	Rated DC
Code	Voltage (V)
е	2.5
g	4
j	6.3
Α	10
С	16
D	20
E	25
V	35

Capacitance	Nominal	Capacitance	Nominal
Code	Capacitance (µF)	Code	Capacitance (µF)
<u>N</u>	0.33	е	15
<u>S</u>	0.47	j	22
Α	1.0	n	33
E	1.5	s	47
J	2.2	а	100
N	3.3	е	150
S	4.7	j	220
а	10	n	330

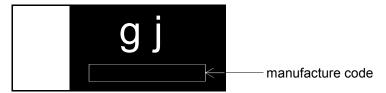
Visual typical example

voltage code and capacitance code are variable with parts number.

[TCS series P case]



- (1) voltage code
- (2) capacitance code



Characteristics

Iten	า	Performance	Test condition (Based on JIS C 5101-1, JIS C 5101-3)			
Operating temperat	ure	-55℃~+125℃	Voltage reduction when temperature exceeds			
			+85℃			
Maximum operating	J	+85°C				
temperature with no)					
voltage derating.						
Rated voltage(V.D0	()	Refer to " Standard list ".	at 85℃			
Category voltage(V	.DC)	Refer to " Standard list ".	at 125°C			
Surge voltage(V.D0	C)	Refer to " Standard list ".	at 85℃			
DC leakage current	:	Shall be satisfied the value on " Standard list ".	As per 4.9 JIS C 5101-1-1			
			As per 4.5.1 JIS C 5101-3			
			Voltage : Rated voltage for 5min.			
Capacitance tolera	nce	Shall be satisfied allowance range.	As per 4.7 JIS C 5101-1			
		±20%	As per 4.5.2 JIS C 5101-3			
			Measuring frequency : 120+12Hz			
			Measuring voltage : 0.5Vrms+1.5V.DC			
			Measuring circuit : DC equivalent series circuit			
Tangent of loss and	jle .	Shall be satisfied the value on " Standard list ".	As per 4.8 JIS C 5101-1			
(Df,tanδ)			As per 4.5.3 JIS C 5101-3			
			Measuring frequency : 120+12Hz			
			Measuring voltage : 0.5Vrms+1.5V.DC			
ESR		Shall be satisfied the value on " Standard list ".	Measuring circuit : DC equivalent series circuit As per 4.10 JIS C 5101-1			
LON		Shall be satisfied the value off. Standard list.	As per 4.5.4 JIS C 5101-3			
			Measuring frequency : 120+12Hz			
			Measuring voltage : 0.5Vrms+1.5V.DC			
			Measuring circuit : DC equivalent series circuit			
Resistance	App-	There should be no significant abnormality.	As per 4.14 JIS C 5101-1			
to soldering	arance	The indications should be clear.	As per 4.6 JIS C 5101-3			
heat	L.C.	Less than 200% of initial limit.	Dip in the solder bath.			
			Solder temp. : 260±10℃			
	⊿C/C	Within ±30% of initial limit.	Duration : 5±0.5s			
			Repetition : 1 After the specimens, leave it at room temperature			
	DF	Less than 200% of initial limit.				
	(tanδ)		for over 24h and then measure the sample.			
Temperature	Арр-	There should be no significant abnormality.	As per 4.16 JIS C 5101-1			
cycle	arance	The indications should be clear.	As per 4.10 JIS C 5101-3			
	L.C.	Less than 200% of initial limit.	Repetition: 5cycles			
	40/0	Makin 1900/ of interest	(1cycle:steps1~4)Without discontinuation			
	⊿C/C	Within ±30% of initial limit.	Toma Time			
	DF	Loop than 2009/ of initial limit	Temp. Time 1 -55°C±3°C 30±3min			
		Less than 200% of initial limit.				
	(tanδ)		2 Room temp. 3min or less 3 125±2°C 30±3min			
			4 Room temp. 3min or less			
			After the specimens, leave it at room temperature			
			Alter the specimens, leave it at room temperature			

Item		Performance	Test condition			
Maiatona	Ann	There also ald be a serious fine at also assessed to	(Based on JIS C 5101-1, JIS C 5101-3)			
Moisture resistance	App- arance	There should be no significant abnormality. The indications should be clear.	As per 4.22 JIS C 5101-1 As per 4.12 JIS C 5101-3			
resistance	L.C.	Less than 200% of initial limit.	After leaving the sample under such atmospheric			
	L.O.	Less than 200 % of finital finite.	condition that the temperature and humidity are			
	⊿C/C	Within ±30% of initial limit.	60±2°C and 90~95%(Relative Humidity),			
		Within 20070 of militar milit.	respectively ,for 500±24h leave it at room			
	DF	Less than 200% of initial limit.	temperature for over 24h and then measure the			
	(tanδ)		sample.			
Temperature	Temp: -55°	C	As per 4.29 JIS C 5101-1			
·	⊿C/C	Within +15/-50% of initial limit.	As per 4.13 JIS C 5101-3			
	tanδ	Shall be satisfied the value on " Standard list ".	7			
	L.C.	-				
	Temp: +85	℃				
	⊿C/C	Within +15/-5% of initial limit.				
	tanō	Shall be satisfied the value on " Standard list ".				
			_			
	L.C.	Less than 1000% of initial limit.				
	Temp : +12		_			
	⊿C/C	Within +20/-5% of initial limit.	-			
		25/ 5/5 5/ 11/10/11/11				
	tanδ	Shall be satisfied the value on " Standard list ".				
	L.C.	Less than 1250% of initial limit.				
Surge voltage	Арр-	There should be no significant abnormality.	As per 4.26 JIS C 5101-1			
	arance	The indications should be clear.	As per 4.14 JIS C 5101-3			
	L.C.	Less than 200% of initial limit.	Apply the specified serge voltage via the serial			
			resistance of 1kΩ ever 5±0.5min for 30±5s each			
	⊿C/C	Within ±30% of initial limit.	time in the atmospheric condition of 85±2°C.			
			Repeat this procedure 1,000 times. After the			
	DF	Less than 200% of initial limit.	specimens, leave it at room temperature for over			
	(tanδ)	<u></u>	24h and then measure the sample.			
Loading at	App-	There should be no significant abnormality.	As per 4.23 JIS C 5101-1			
high	arance	The indications should be clear.	As per 4.15 JIS C 5101-3			
temperature	L.C.	Less than 200% of initial limit.	After applying the rated voltage for 1000+36/0h			
	10/0	MEH. 2009/ ACCURATE TO	without discontinuation via the serial resistance			
	⊿C/C	Within ±30% of initial limit.	of 3Ωor less at a temperature of 85±2°C , leave			
	DE	Loca than 2000/ of initial limit	the sample at room temperature/humidity for			
	DF (tapā)	Less than 200% of initial limit.	over 24h and measure the value.			
	(tanδ)					

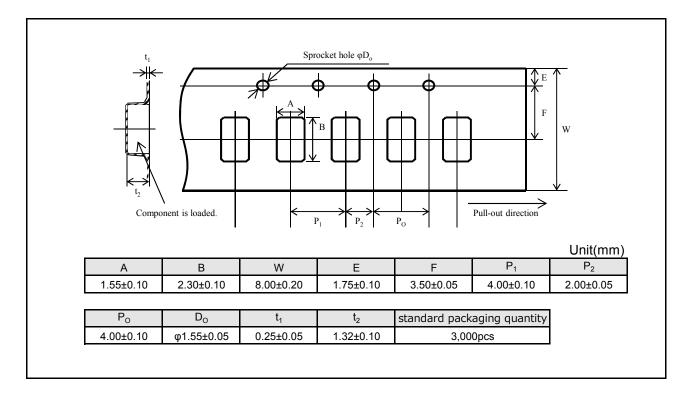
Datasheet

Item	า	Performance	Test condition (Record on U.S.C. 5101.1. U.S.C. 5101.3.)			
Tarminal	Cono	The manufactured value should be stable	(Based on JIS C 5101-1, JIS C 5101-3)			
Terminal	Capa- citance	The measured value should be stable.	As per 4.35 JIS C 5101-1			
strength			As per 4.9 JIS C 5101-3			
	App-	There should be no significant abnormality.	A force is applied to the terminal until it bends			
	arance		to 1mm and by a prescribed tool maintains the			
			Unit(mm)			
			50			
			F(Apply force)			
			R230 V			
			1.0mm			
			thickness=1.6mm			
			$\mathcal{L} = \mathcal{L} = \mathcal{L} = \mathcal{L}$			
			45 45			
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1			
, tancor enece		The terminal enough her come on:	As per 4.8 JIS C 5101-3			
			Apply force of 5N in the two directions shown			
			in he figure below for 10±1s after mounting the			
			terminal on a circuit board.			
			Products			
			[
			Apply force			
			\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\			
			A circuit board			
Dimensions		Refer to "External dimensions"	Measure using a caliper of JIS B 7507 class 2			
			or higher grade.			
Resistance to solve	nts	The indication should be clear.	As per 4.32 JIS C 5101-1			
			As per 4.18 JIS C 5101-3			
			Dip in the isopropyl alcohol for 30±5s ,			
			at room temperature.			
Solder ability		3/4 or more surface area of the solder	As per 4.15.2 JIS C 5101-1			
		coated terminal dipped in the soldering	As per 4.7 JIS C 5101-3			
		bath should be covered with the new	Dip speed : 25±2.5mm/s			
		solder.	Pre-treatment : Leave the sample on the boiling			
			(accelerated aging)			
			Solder temp : 245±5℃			
			Duration : 3±0.5s			
			Solder : M705			
			Flux : Rosin 25%			
			IPA 75%			
Vibration Capa-		Measure value should not fluctuate	As per 4.17 JIS C 5101-1			
citano		during the measurement.	Frequency: 10~55~10Hz/min.			
		There should be no significant abnormality.	Amplitude : 1.5mm			
	arance		Time : 2h each in X,Y and Z directions.			
			Mounting : The terminal is soldered on a			
		1	print circuit board.			

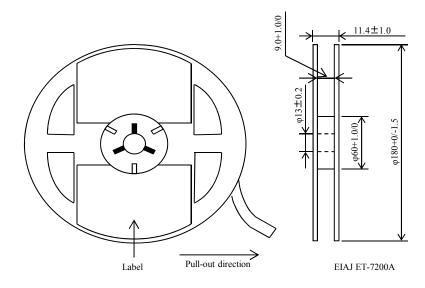
Standard products list

	Rated	Category	Surge	Сар.	Tole-	Leakage		tanδ		ESR
	voltage	voltage	voltage		rance	current				
Doub No.	85℃	105℃	85℃	120Hz		25℃		120Hz		100kHz
Part No						1WV	-55℃	25℃	125℃	
						5min		85℃		
	(V)	(V)	(V)	(µF)	(%)	(µA)	(%)	(%)	(%)	(Ω)
TCSP0G227M8R-V1	4	2.5	4	220	±20	88.0	80	40	60	3.0
TCSP0J107M8R-V1	6.3	4	6.3	100	±20	63.0	80	40	60	3.0
TCSP0J157M8R-V1	6.3	4	6.3	150	±20	95.0	80	40	60	3.0
TCSP1A476M8R	10	6.3	13	47	±20	24.0	60	30	40	4.0
TCSP1D106M8R	20	13	26	10	±20	10.0	30	20	30	6.0

Packaging specifications



Reel dimensions



Notice

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Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

1 /				
JAPA	N	USA	EU	CHINA
CLASS	эш	CLASSIII	CLASS II b	CLASSIII
CLASS	SIV	CLASSIII	CLASSⅢ	CLASSIII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.004

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TCSCS1A476KBAR T83E107K016RCCL T83D685K035RCCL 595D107X0004B2T CWR11HH105KB 293D155X9020A2DE3
CWR09NC224KB CWR11MC685KCB CWR29FC685KCEC CWR09NC684KM CWR19MH106KCHB CWR29HH155KCBB
CWR29FC336KDGC CWR09NC225KDB CWR29FC475KDDC CWR29HC225KCAC CWR11KC106KBB CWR09JH105KC
293D476X9035E2TE3 CWR29JC335KDDC CWR29KC226JCGC CWR29FC105KDAC CWR29DC337KCHC NTC-T686K6.3TRBF
595D686X9010B2T 594D686X9016C2T 595D106X0025C8T TAZH685K035LBSB0824 TAZG107K010LBSB0800
TAZH475K050LBSB0H23 TAJD107K016KNJ TAZH227K010LBSB0024 TAZH156K025CBSZ0824 TAZH227J010LBSZ0800
TPSE687M006H0045 TBJD156K025CBSZ0824 TMCSA1V154MTRF TMCSA0G335MTRF